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# N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 131 A, 2.5 m $\Omega$

### Features

- Max  $r_{DS(on)} = 2.5 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Max  $r_{DS(on)}$  = 3.6 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 21.5 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

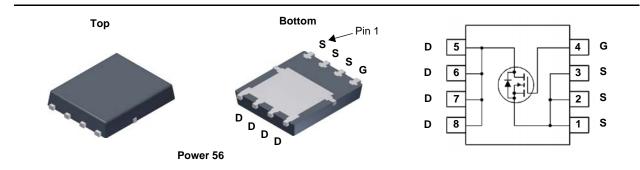


# **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed ang body diode reverse recovery performance.

# Applications

- VRM Vcore Switching For Desktop And Server
- OringFET / Load Switching
- DC-DC Conversion
- Motor Bridge Switch



# MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			30	V
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 6)	131	
	-Continuous	T <sub>C</sub> = 100 °C	(Note 6)	83	٥
D	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	26	— A
	-Pulsed		(Note 5)	507	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	93	mJ
D	Power Dissipation	T <sub>C</sub> = 25 °C		65	14/
PD	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

#### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction-to-Case	1.9	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient (Note 1a	50	C/vv

#### Package Marking and Ordering Information

Device N	Device Marking Device		Package	Reel Size	Tape Width	Quantity	
FDMS	8020	FDMS8020	Power 56	13 "	12 mm	3000 units	

May 2015

Тур	Max	Units
		V
14		mV/°C
	1	μA
	100	nA
1.5	3.0	V
-6		mV/°C
2.0	2.5	
2.6	3.6	mΩ
2.9	3.7	1
154		S
2855	3800	pF
1050	1400	pF

FDMS8020 N-Channel PowerTrench<sup>®</sup> MOSFET

# **Dynamic Characteristics**

Symbol

 $BV_{DSS}$ 

 $\Delta BV_{DSS}$ 

 $\Delta T_{J}$ 

I<sub>DSS</sub>

I<sub>GSS</sub>

V<sub>GS(th)</sub>

 $\Delta T_{J}$ 

r<sub>DS(on)</sub>

**g**fs

 $\Delta V_{GS(th)}$ 

**Off Characteristics** 

**On Characteristics** 

Coefficient

Electrical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted.

Gate to Source Leakage Current, Forward V<sub>GS</sub> = 20 V, V<sub>DS</sub> = 0 V

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

Gate to Source Threshold Voltage

Gate to Source Threshold Voltage

Static Drain to Source On Resistance

**Temperature Coefficient** 

Forward Transconductance

C <sub>iss</sub>	Input Capacitance		2855	3800	pF
C <sub>oss</sub>	Output Capacitance	──── V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	1050	1400	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		115	175	pF
Rg	Gate Resistance		0.9		Ω

**Test Conditions** 

 $I_D = 250 \ \mu A$ , referenced to 25 °C

 $I_D = 250 \ \mu A$ , referenced to 25 °C

 $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 26 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$ 

 $I_D=250~\mu\text{A},~V_{GS}=0~V$ 

 $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ 

 $V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$ 

V<sub>GS</sub> = 10 V, I<sub>D</sub> = 26 A V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 21.5 A

 $V_{DS} = 5 V, I_{D} = 26 A$ 

Min

30

1.0

## **Switching Characteristics**

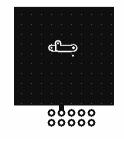
t <sub>d(on)</sub>	Turn-On Delay Time		12	22	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 26 A,	5.7	12	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{DD}$ = 15 V, I <sub>D</sub> = 26 A, V <sub>GS</sub> = 10 V, R <sub>GEN</sub> = 6 Ω	32	52	ns
t <sub>f</sub>	Fall Time		4	10	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	43	61	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$	21	29	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 26 A	7.3		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		6.0		nC

### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$	(Note 2)	0.68	1.1	V
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 26 A$	(Note 2)	0.78	1.2	v
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 26 A, di/dt = 100 A/μs		37	58	ns
Q <sub>rr</sub>	Reverse Recovery Charge			18	33	nC
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 26 A, di/dt = 300 A/μs		30	48	ns
Q <sub>rr</sub>	Reverse Recovery Charge			36	57	nC

Notes:

1. R<sub>0,JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



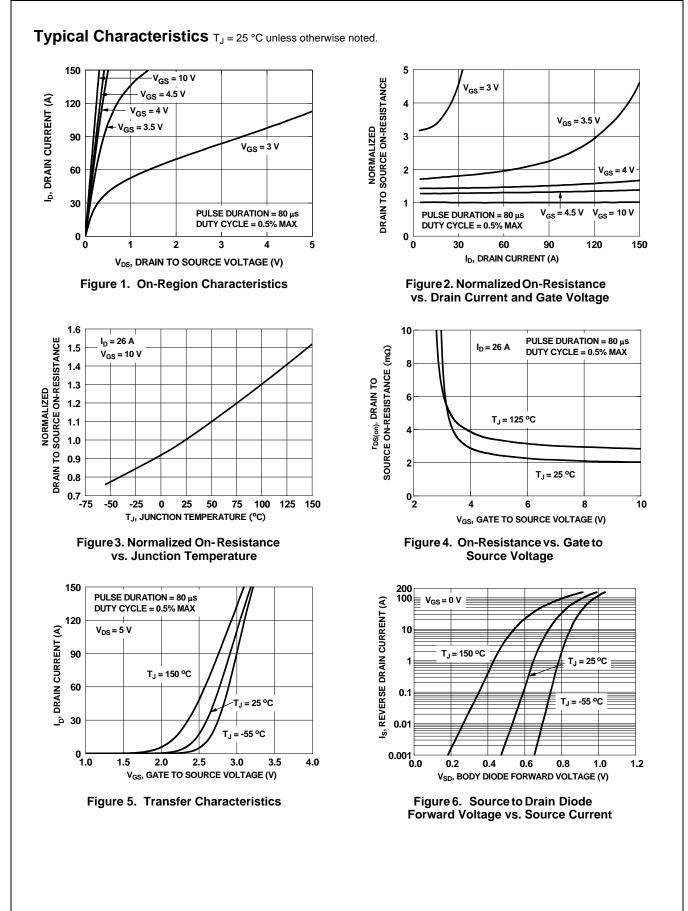
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

- 3. Starting T\_J = 25 °C; N-ch: L = 0.3 mH, I\_{AS} = 25 A, V\_DD = 27 V, V\_GS = 10 V.
- 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

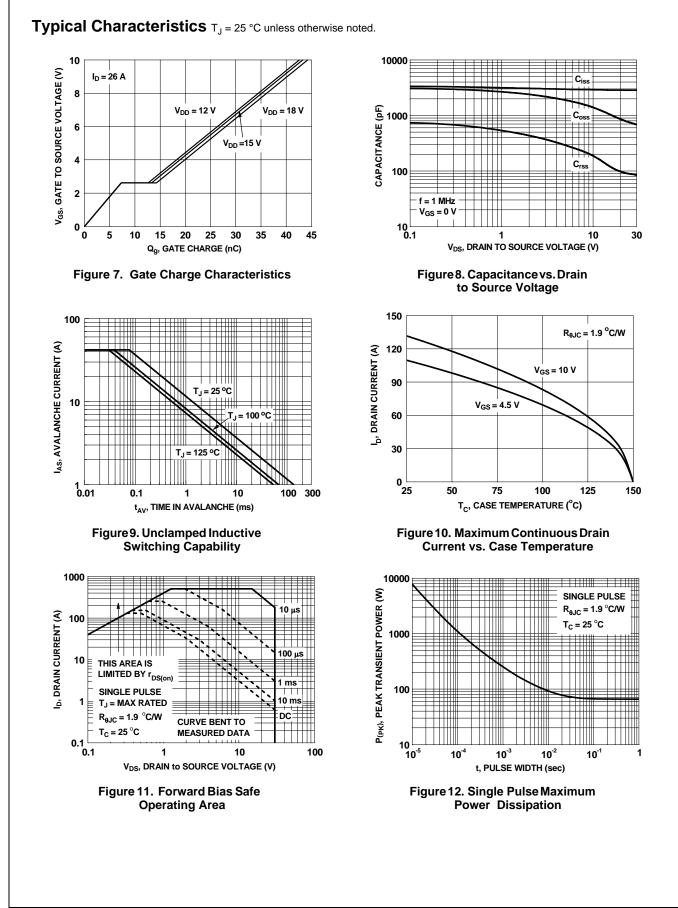
5. Pulsed Id please refer to SOA curve for more details.

6. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

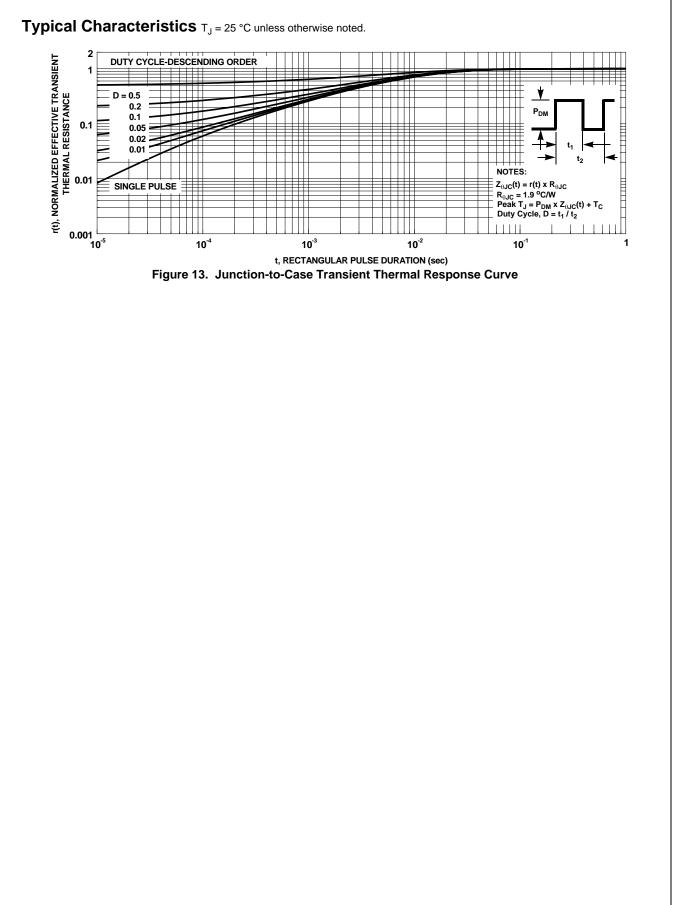


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FDMS8020 N-Channel PowerTrench<sup>®</sup> MOSFET



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